

**GigaDevice Semiconductor Inc.**

**Arm<sup>®</sup> Cortex<sup>®</sup>- M3/M4/M23/M33 32-bit MCU**

**Application Note  
AN022**

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## 1. Introduction

SDRAM is short for Synchronous Dynamic Random Access Memory. Synchronization means that memory work needs to synchronize clock, and internal command sending and data transmission are based on it; Dynamic means that the storage array needs constant refresh to ensure that the stored data is not lost. Because the data stored in SDRAM works through the capacitor, because the capacitor will discharge in the natural state, if the discharge is finished, it means that the data in SDRAM is lost, so SDRAM needs to refresh before the discharge of the capacitor is finished. Random means that the data is not stored in linear order, but read and write the data freely at the specified address.

Since SDRAM has some of the same characteristics as SRAM, if you need to run code on SDRAM, in addition to using MPU, you can also map SDRAM Device0 address (0xC0000000) to 0x00000000 to run the code stored in SDRAM. This article introduces how to map SDRAM Device0 address (0xC0000000) to 0x00000000 to run the code on GD32F450. Among them, APP\_GPIO\_Running\_LED is the APP program programmed to SDRAM Device0 address (0xC0000000). BOOT\_EXMC\_SDRAM is the BOOT program programmed to address 0x08000000.

## 2. FLM file

### 2.1. Custom SDRAM\_256Mb.FLM file

This AN is based on GD32F450Z-EVAL evaluation board, equipped with a MT48LZ16M16 A2P-6AIT SDRAM with a capacity of 256Mb.

When making FLM files, the starting address is 0x00000000. The details are shown in [Figure 2-1. Address range of FLM file](#).

**Figure 2-1. Address range of FLM file**

Description	Device Size	Device Type	Address Range
SDRAM_256Mb	256M	Unknown Device	00000000H - 0FFFFFFFH

### 2.2. Copy the FLM file to the Keil 5 installation path

Copy the SDRAM\_256Mb.FLM file to the Keil 5 installation path, generally "C:\Keil\_v5\ARM\FIash".

### 3. APP\_GPIO\_Running\_LED project

#### 3.1. Modify the project scatter-loading file

Since the APP\_GPIO\_Running\_LED code is to run at address 0x00000000, it is necessary to modify the scatter-loading file of the project and load it to address 0x00000000. The details are shown in [Table 3-1. Scatter-loading file of APP\\_GPIO\\_Running\\_LED](#).

**Table 3-1. Scatter-loading file of APP\_GPIO\_Running\_LED**

```

LR_IROM1 0x00000000 0x00100000 { ; load region size_region
  ER_IROM1 0x00000000 0x00100000 { ; load address = execution address
    *.o (RESET, +First)
    *(InRoot$$Sections)
    .ANY (+RO)
    .ANY (+XO)
  }
  RW_IRAM1 0x20000000 0x00030000 { ; RW data
    .ANY (+RW +ZI)
  }
}
  
```

#### 3.2. Modify the entry address of the interrupt vector table

Since the code itself runs at address 0x00000000, it is necessary to modify the entry address of the interrupt vector table of the APP project. You need to call `nvic_vector_table_set` at the appropriate location and set the entry address of the interrupt vector table to 0x00000000 and the offset to 0, as shown in [Table 3-2. Setting the entry address of interrupt vector table](#).

Table 3-2. Setting the entry address of interrupt vector table

```

  /*!
   \brief      main function
   \param[in]  none
   \param[out] none
   \retval    none
  */
  int main(void)
  {
      nvic_vector_table_set(0, 0);
      /* configure systick */
      systick_config();

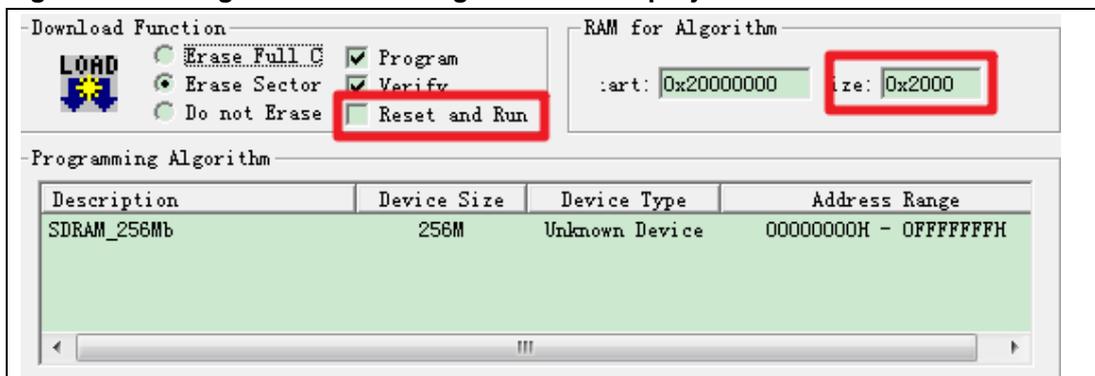
      .....
  }

```

### 3.3. Add the SDRAM\_256Mb.FLM file to the Keil project

Open the Keil project, in the Keil Flash download interface, add the SDRAM\_256Mb.FLM file, and change the RAM for Algorithm Size to 0x2000, as shown in [Figure 3-1. Configuration of Flash Algorithm in Keil project](#). Then download the program to SDRAM.

Figure 3-1. Configuration of Flash Algorithm in Keil project



## 4. BOOT\_EXMC\_SDRAM project

In the BOOT\_EXMC\_SDRAM project, you need to change the BOOT\_MODE of the SYSCFG\_CFG0 register to 0b`100. The specific implementation is shown in [Table 4-1. Set boot mode to EXMC SDRAM](#).

**Table 4-1. Set boot mode to EXMC SDRAM**

```

.....
rcu_periph_clock_enable(RCU_SYSCFG);
syscfg_bootmode_config(SYSCFG_BOOTMODE_EXMC_SDRAM);
.....

```

If EXMC clock is enabled and EXMC SDRAM has been configured in BOOT\_EXMC\_SDRAM, you can observe the value of SDRAM through debugging to see if it is the APP\_GPIO\_Running\_LED code. The details are shown in [Figure 4-1. The value of 0xC0000000 in debug mode](#) and [Figure 4-2. The bin file compiled by the APP GPIO Running LED project](#).

**Figure 4-1. The value of 0xC0000000 in debug mode**

Memory 1				
Address: 0xC0000000				
0xC0000000:	20000408	000001C1	00000211	0000020D
0xC0000010:	0000020F	00000209	00000289	00000000
0xC0000020:	00000000	00000000	00000000	00000215
0xC0000030:	0000020B	00000000	00000213	00000217
0xC0000040:	000001DB	000001DB	000001DB	000001DB
0xC0000050:	000001DB	000001DB	000001DB	000001DB
0xC0000060:	000001DB	000001DB	000001DB	000001DB
0xC0000070:	000001DB	000001DB	000001DB	000001DB
0xC0000080:	000001DB	000001DB	000001DB	000001DB
0xC0000090:	000001DB	000001DB	000001DB	000001DB
0xC00000A0:	000001DB	000001DB	000001DB	000001DB
0xC00000B0:	000001DB	000001DB	000001DB	000001DB
0xC00000C0:	000001DB	000001DB	000001DB	000001DB
0xC00000D0:	000001DB	000001DB	000001DB	000001DB
0xC00000E0:	000001DB	000001DB	000001DB	000001DB
0xC00000F0:	000001DB	000001DB	000001DB	000001DB
0xC0000100:	000001DB	000001DB	000001DB	000001DB
0xC0000110:	000001DB	000001DB	000001DB	000001DB
0xC0000120:	000001DB	000001DB	000001DB	000001DB
0xC0000130:	000001DB	000001DB	000001DB	000001DB
0xC0000140:	000001DB	000001DB	000001DB	000001DB
0xC0000150:	000001DB	000001DB	000001DB	000001DB
0xC0000160:	000001DB	000001DB	000001DB	000001DB
0xC0000170:	000001DB	000001DB	000001DB	00000000
0xC0000180:	000001DB	000001DB	000001DB	000001DB
0xC0000190:	000001DB	000001DB	000001DB	00000000
0xC00001A0:	000001DB	000001DB	000001DB	D00CF8DF
0xC00001B0:	F818F000	47004800	0000037D	20000408
0xC00001C0:	47804806	47004806	E7FEE7FE	E7FEE7FE
0xC00001D0:	E7FEE7FE	E7FEE7FE	E7FEE7FE	0000021D
0xC00001E0:	000001AD	4D074C06	68E0E006	0301F040
0xC00001F0:	0007E894	34104798	D3F642AC	FFDAF7FF
0xC0000200:	0000056C	0000058C	4770E7FE	E7FEE7FE
0xC0000210:	47704770	F0004770	0000B85F	B4184816
0xC0000220:	F4416801	60010170	68104A14	0001F040
0xC0000230:	4C126010	68203408	0080F040	23006020

Figure 4-2. The bin file compiled by the APP\_GPIO\_Running\_LED project

Address	0	4	8	C	ASCII
0000	20000408	000001C1	00000211	0000020D	.....
0010	0000020F	00000209	00000289	00000000	.....
0020	00000000	00000000	00000000	00000215	.....
0030	0000020B	00000000	00000213	00000217	.....
0040	000001DB	000001DB	000001DB	000001DB	.....
0050	000001DB	000001DB	000001DB	000001DB	.....
0060	000001DB	000001DB	000001DB	000001DB	.....
0070	000001DB	000001DB	000001DB	000001DB	.....
0080	000001DB	000001DB	000001DB	000001DB	.....
0090	000001DB	000001DB	000001DB	000001DB	.....
00A0	000001DB	000001DB	000001DB	000001DB	.....
00B0	000001DB	000001DB	000001DB	000001DB	.....
00C0	000001DB	000001DB	000001DB	000001DB	.....
00D0	000001DB	000001DB	000001DB	000001DB	.....
00E0	000001DB	000001DB	000001DB	000001DB	.....
00F0	000001DB	000001DB	000001DB	000001DB	.....
0100	000001DB	000001DB	000001DB	000001DB	.....
0110	000001DB	000001DB	000001DB	000001DB	.....
0120	000001DB	000001DB	000001DB	000001DB	.....
0130	000001DB	000001DB	000001DB	000001DB	.....
0140	000001DB	000001DB	000001DB	000001DB	.....
0150	000001DB	000001DB	000001DB	000001DB	.....
0160	000001DB	000001DB	000001DB	000001DB	.....

After configuring the BOOT\_MODE of the SYSCFG\_CFG0 register to 0b`100, you need to jump the program to the address where the APP\_GPIO\_Running\_LED project is located to run the code. The specific configuration is shown in [Table 4-2. Jump to the address where the APP project is located to run the code.](#)

**Table 4-2. Jump to the address where the APP project is located to run the code**

```
typedef void (*pFunction)(void);
#define ApplicationAddress      0xC0000000

pFunction Jump_To_Application;
uint32_t JumpAddress = 0;

.....
    if (((__IO uint32_t*)ApplicationAddress) & 0x2FFE0000 ) == 0x20000000) {
        JumpAddress = *((__IO uint32_t*) (ApplicationAddress + 4));
        Jump_To_Application = (pFunction) JumpAddress;
        __set_MSP((__IO uint32_t*) ApplicationAddress);
        Jump_To_Application();
    }
.....
```

After resetting the chip, it can be observed that the APP code is already running normally.

## 5. Revision history

Table 5-1. Revision history

Revision No.	Description	Date
1.0	Initial Release	Nov.30 2021

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